

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Drain-Source Voltage		V_{DSS}	60	V
Gate-Source Voltage		V _{GSS}	±20	V
Continuous Drain Current, V _{GS} = 10V (Notes 6 & 9)	$T_{C} = +25^{\circ}C$	I _D	100	A
	$T_C = +70$ °C		100	
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)		I _{DM}	400	Α
Continuous Body Diode Forward Current (Note 6)	T _C = +25°C	I _S	100	Α
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle = 1%)		I _{SM}	400	Α
Avalanche Current, L = 3mH		I _{AS}	14	Α
Avalanche Energy, L = 3mH		E _{AS}	294	mJ

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 5)	P _D	2.3	W
Thermal Resistance, Junction to Ambient (Note 5)	$R_{\theta JA}$	55	°C/W
Total Power Dissipation (Note 6)	P _D	167	W
Thermal Resistance, Junction to Case (Note 6)	R _{eJC}	0.9	°C/W
Operating and Storage Temperature Range	T _{J,} T _{STG}	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

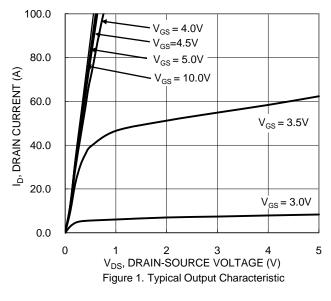
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV _{DSS}	60	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current	I _{DSS}	-	_	1	μΑ	$V_{DS} = 48V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V _{GS(TH)}	1	_	3	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	
Static Drain-Source On-Resistance			1.5	2	mΩ	$V_{GS} = 10V, I_D = 50A$	
Static Diani-Source On-Resistance	R _{DS(ON)}	-	2.2	3	11152	$V_{GS} = 6V, I_D = 50A$	
Diode Forward Voltage	V_{SD}	_	_	1.2	V	$V_{GS} = 0V, I_{S} = 50A$	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	Ciss	_	6555	_		$V_{DS} = 30V$, $V_{GS} = 0V$, $f = 1MHz$	
Output Capacitance	Coss	_	2264	_	pF		
Reverse Transfer Capacitance	C _{rss}	_	187	_			
Gate Resistance	Rg	_	0.7	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (V _{GS} = 10V)	Q_g	_	130.8	_			
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	63.6	_	nC	V _{DS} = 30V, I _D = 50A	
Gate-Source Charge	Q_{gs}	_	20.8	_	IIC		
Gate-Drain Charge	Q_{qd}	_	29.4	_		<u> </u>	
Turn-On Delay Time	t _{D(ON)}	_	11.2	_		$V_{DD} = 20V, V_{GS} = 10V,$ $I_{D} = 50A, R_{g} = 2.5\Omega$	
Turn-On Rise Time	t _R	_	10.8	_			
Turn-Off Delay Time	t _{D(OFF)}		44	_	ns		
Turn-Off Fall Time	t _F	_	19.5	_			
Reverse Recovery Time	t _{RR}	_	61.8	_	ns	L 50A 4:/4t 400A/	
Reverse Recovery Charge	Q _{RR}	_	123	_	$\frac{100}{\text{nC}}$ I _F = 50A, di/dt = 100A/µs		

5. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.

^{6.} Thermal resistance from junction to soldering point (on the exposed drain pad).7. Short duration pulse test used to minimize self-heating effect.

Guaranteed by design. Not subject to product testing.
 Package limited.





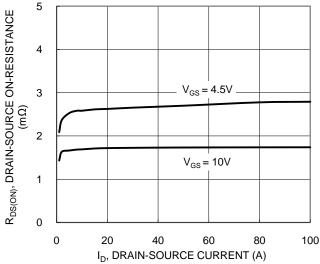


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

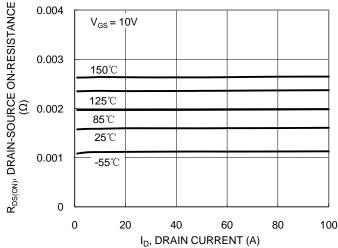
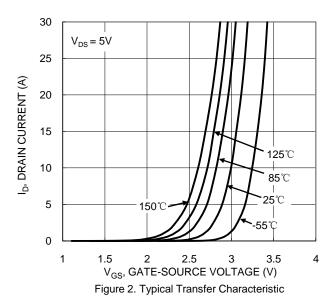
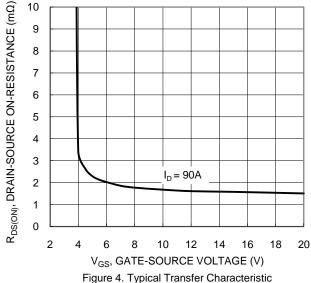


Figure 5. Typical On-Resistance vs. Drain Current and Temperature





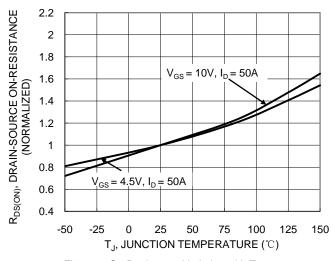


Figure 6. On-Resistance Variation with Temperature





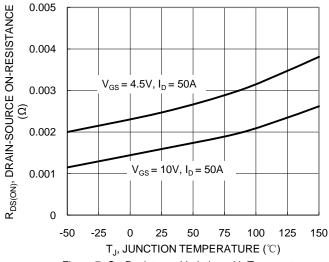


Figure 7. On-Resistance Variation with Temperature

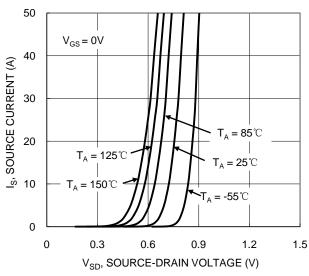
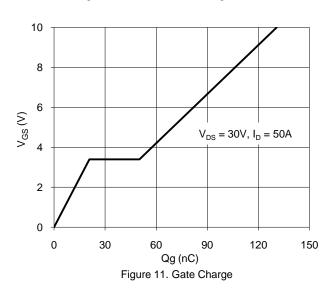
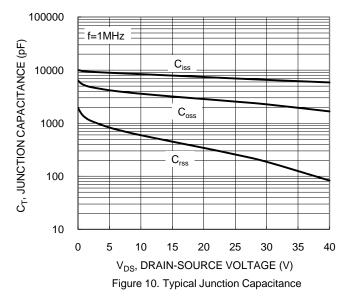


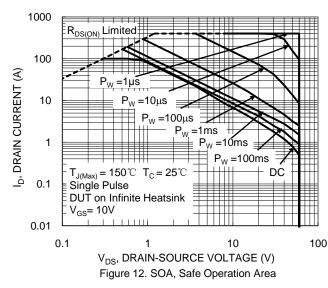
Figure 9. Diode Forward Voltage vs. Current



2.4 $V_{\text{GS(TH)}}$, GATE THRESHOLD VOLTAGE (V) 2.2 2 $I_D = 1mA$ 1.8 1.6 $I_{D} = 250 \mu A$ 1.4 1.2 1 8.0 0.6 0.4 -50 -25 0 25 50 75 100 125 150 T_J , JUNCTION TEMPERATURE (°C)

Figure 8. Gate Threshold Variation vs. JunctionTemperature







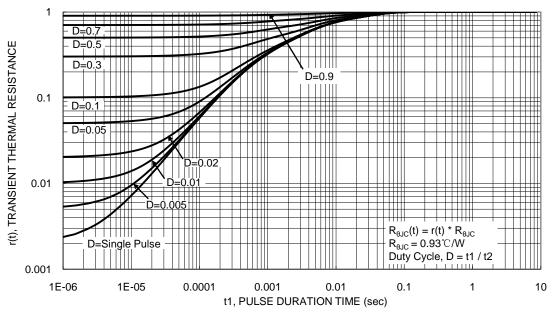


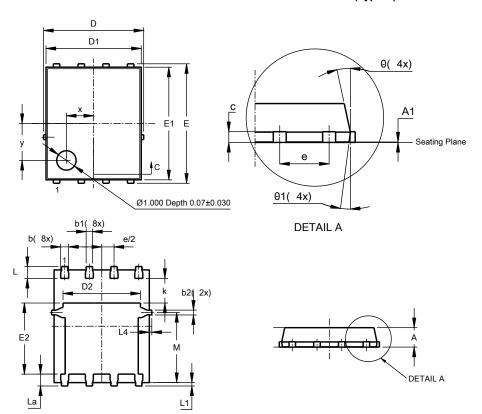
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8 (Type K)

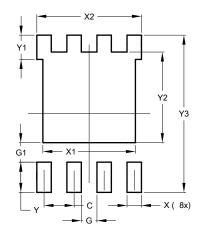


PowerDI5060-8 (Type K)					
Dim	Min	Max	Тур		
Α	0.90	1.10	1.00		
A1	0	0.05	0.02		
b	0.33	0.51	0.41		
b1	0.300	0.366	0.333		
b2	0.20	0.35	0.25		
C	0.23	0.33	0.277		
D	5.15 BSC				
D1	4.85	4.95	4.90		
D2	-	-	3.98		
Е	6.15 BSC				
E1	5.75	5.85	5.80		
E2	3.56	3.725	3.66		
е	1.27BSC				
k	-	-	1.27		
L	0.51	0.71	0.61		
La	0.51	0.675	0.61		
L1	0.05	0.20	0.175		
L4	-	-	0.125		
М	3.50	3.71	3.605		
Х	-	-	1.400		
у	-	-	1.900		
θ	10°	12°	11°		
θ1	6°	8°	7°		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8 (Type K)



Dimensions	Value (in mm)
С	1.270
G	0.660
G1	0.820
X	0.610
X1	3.910
X2	4.420
Y	1.270
Y1	1.020
Y2	3.810
Y3	6.610



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7 of 7

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